



# 8NM120

*Power MOSFET*

## 8.0A, 1200V N-CHANNEL SUPER-JUNCTION MOSFET

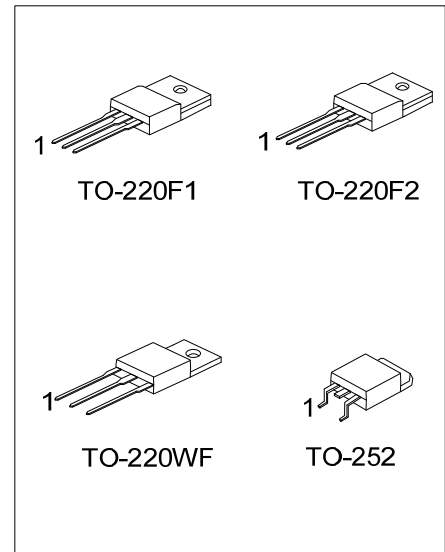
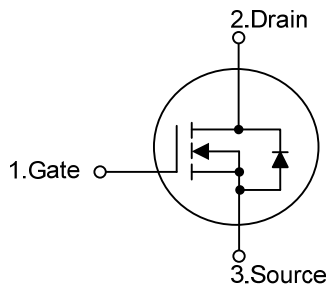
■ DESCRIPTION

The UTC **8NM120** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

■ FEATURES

- \*  $R_{DS(ON)} \leq 1.35 \Omega @ V_{GS}=10V, I_D=4.0A$
- \* High Switching Speed

■ SYMBOL



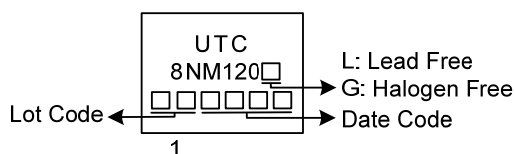
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
8NM120L-TF1-T	8NM120G-TF1-T	TO-220F1	G	D	S	Tube
8NM120L-TF2-T	8NM120G-TF2-T	TO-220F2	G	D	S	Tube
8NM120L-TW1-T	8NM120G-TW1-T	TO-220WF	G	D	S	Tube
8NM120L-TN3-R	8NM120G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>8NM120G-TF1-T</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel (2) TF1: TO-220F1, TF2: TO-220F2, TW1: TO-220WF TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	1200	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Continuous Drain Current	Continuous	I <sub>D</sub>	8	A
	Pulsed	I <sub>DM</sub>	24	A
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	288	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.6	V/ns
Power Dissipation	TO-220F1/TO-220F2	P <sub>D</sub>	29	W
	TO-220WF			
	TO-252		42	W
Junction Temperature		T <sub>J</sub>	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 100mH, I<sub>AS</sub> = 2.4A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 Ω Starting T<sub>J</sub> = 25°C

4. I<sub>SD</sub> ≤ 8.0A, di/dt ≤ 200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220F1/TO-220F2	θ <sub>JA</sub>	62.5	°C/W
	TO-220WF			
	TO-252		110	°C/W
Junction to Case	TO-220F1/TO-220F2	θ <sub>JC</sub>	4.31	°C/W
	TO-220WF			
	TO-252		2.97 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

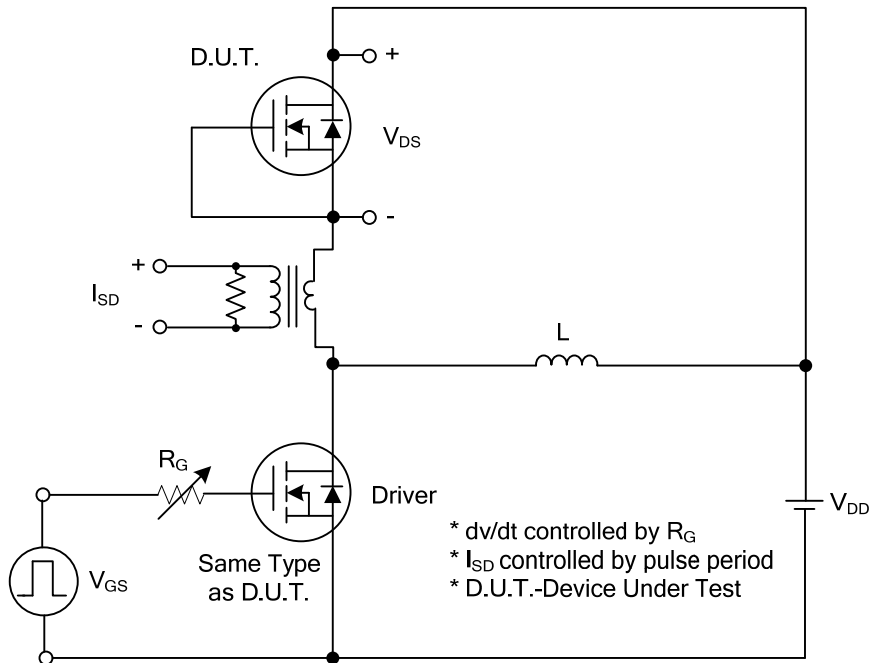
■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	1200			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =1200V, V <sub>GS</sub> =0V			10	μA
Gate-Source Leakage Current	Forward	I <sub>GSS</sub> V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V			+100	nA
	Reverse		V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.5		4.5	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =4.0A			1.35	Ω
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =50V, f=1.0MHz		920		pF
Output Capacitance	C <sub>OSS</sub>			50		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			3		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> =960V, V <sub>GS</sub> =10V, I <sub>D</sub> =8.0A (Note 1, 2)		52		nC
Gate to Source Charge	Q <sub>GS</sub>			12		nC
Gate to Drain Charge	Q <sub>GD</sub>			19		nC
Turn-ON Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =8.0A, R <sub>G</sub> =25Ω (Note 1, 2)		8		ns
Rise Time	t <sub>R</sub>			18		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>			39		ns
Fall-Time	t <sub>F</sub>			23		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	I <sub>S</sub>				8	A
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>				24	A
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =8.0A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>S</sub> =8.0A, V <sub>GS</sub> =0V, dI <sub>F</sub> /dt=100A/μs (Note 1)		664		ns
Reverse Recovery Charge	Q <sub>rr</sub>				9	

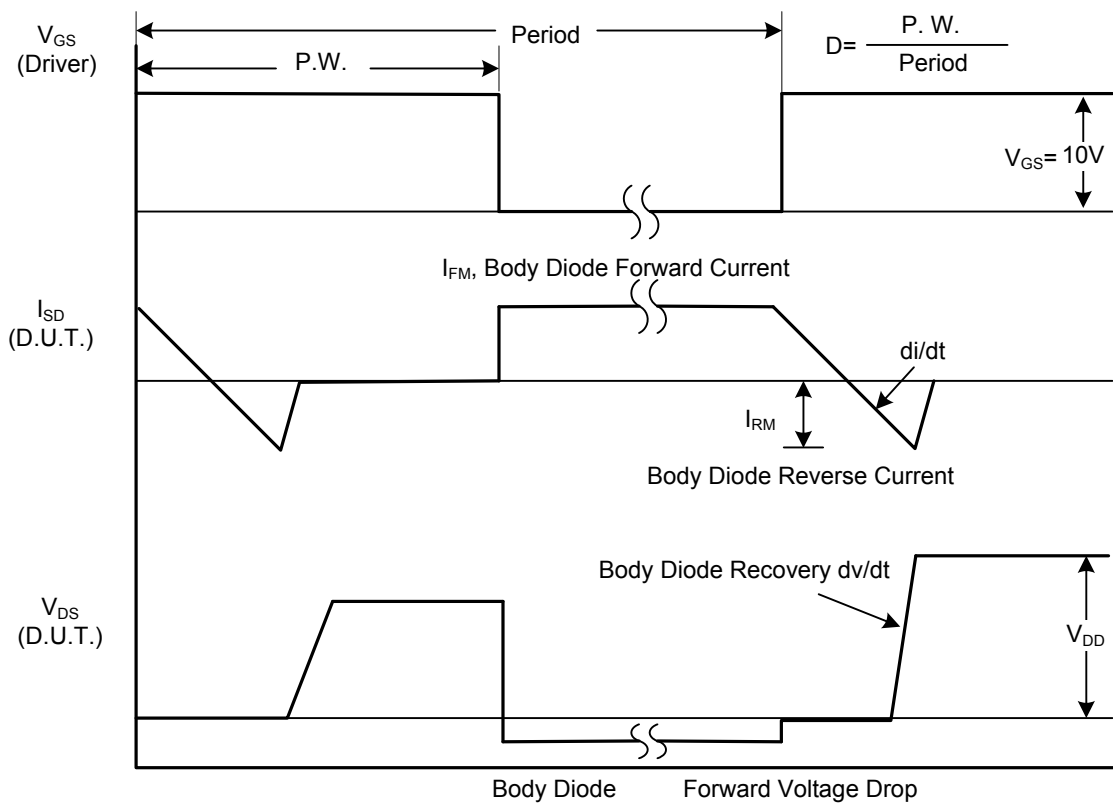
Notes: 1. Pulse Test: Pulse width ≤ 1200μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

## TEST CIRCUITS AND WAVEFORMS

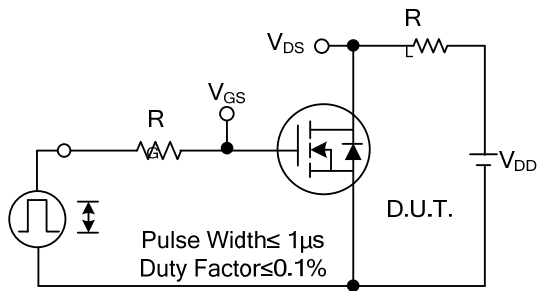


**Peak Diode Recovery dv/dt Test Circuit**

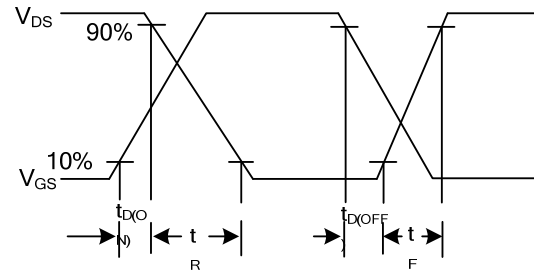


**Peak Diode Recovery dv/dt Waveforms**

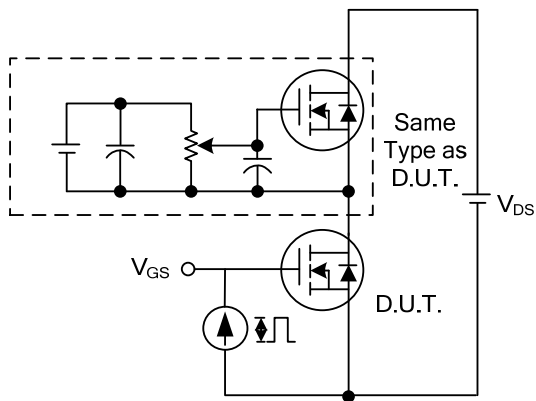
## TEST CIRCUITS AND WAVEFORMS



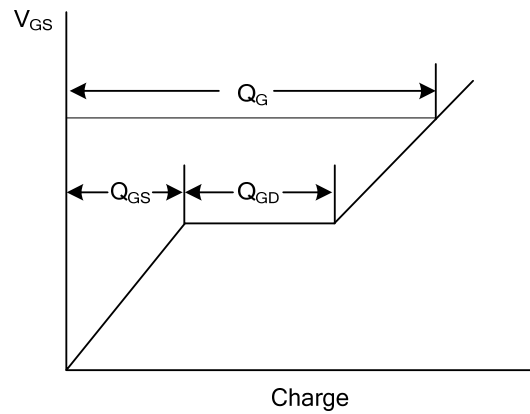
Switching Test Circuit



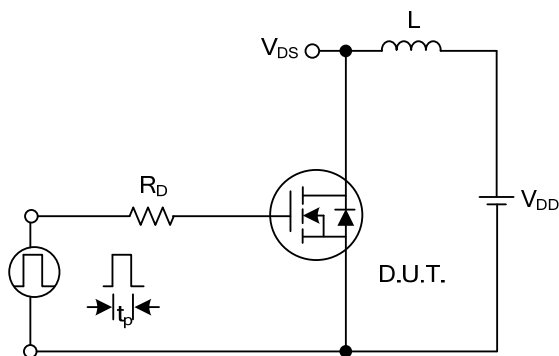
Switching Waveforms



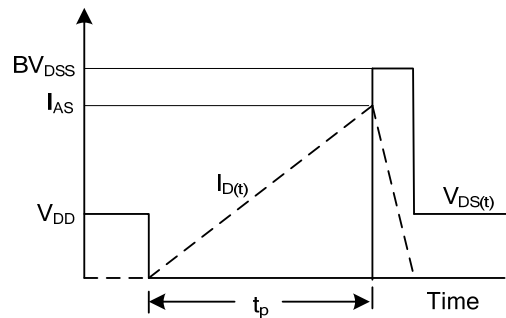
Gate Charge Test Circuit



Gate Charge Waveform

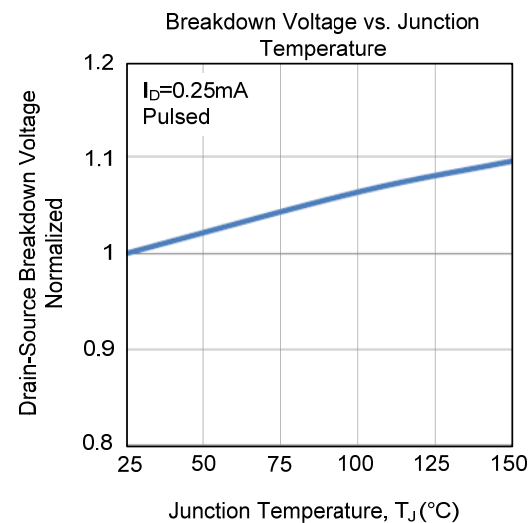
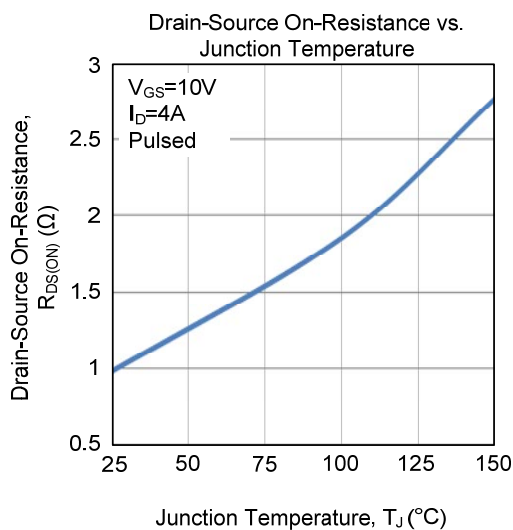
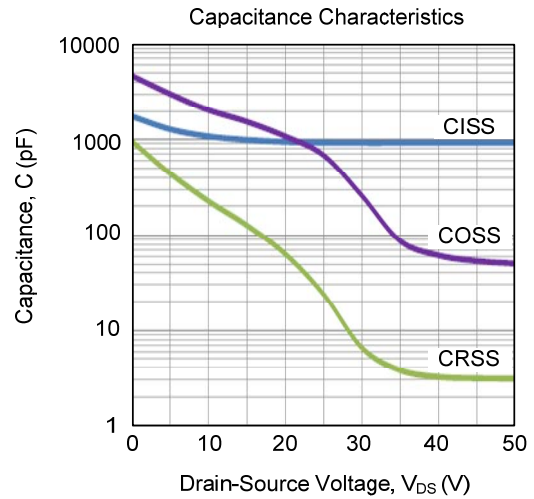
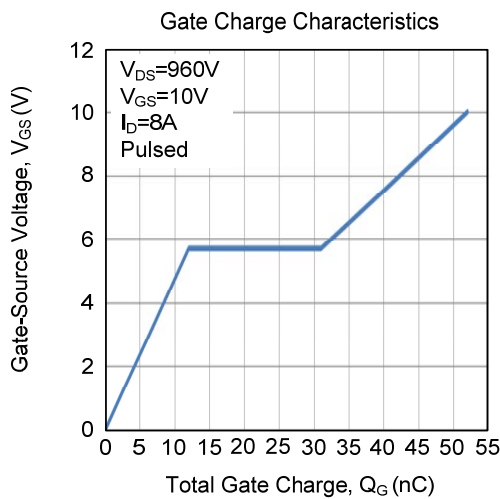
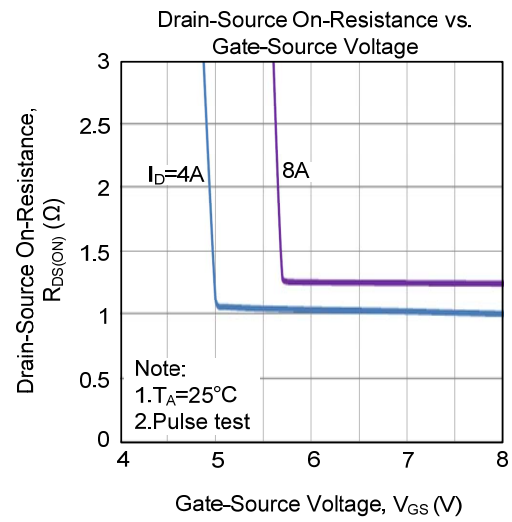
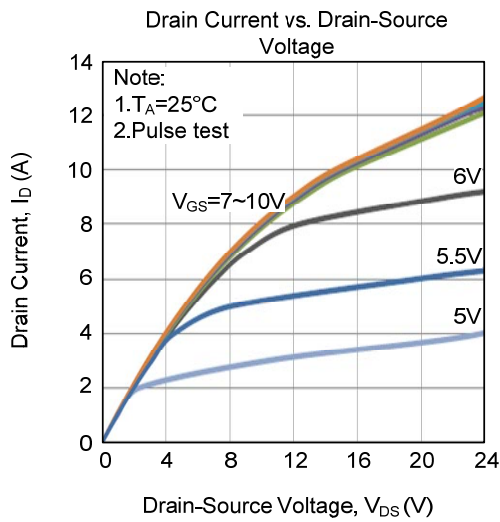


Unclamped Inductive Switching Test Circuit

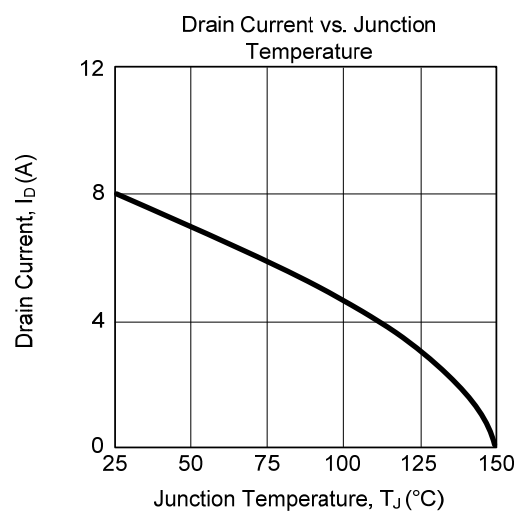
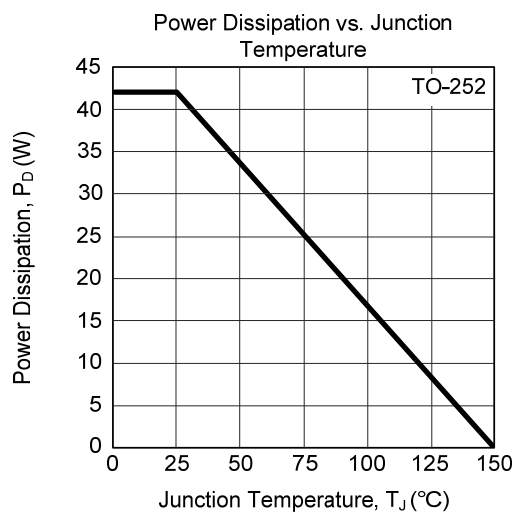
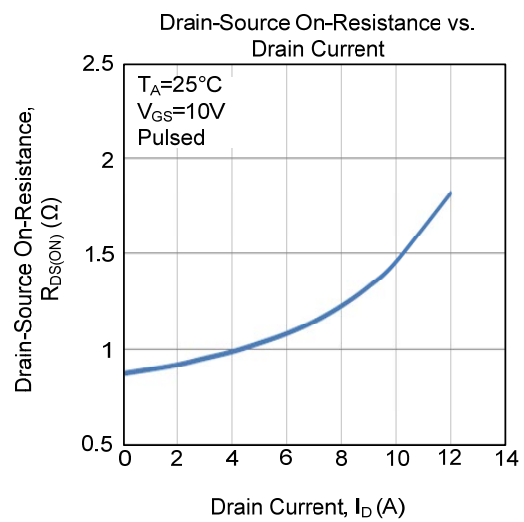
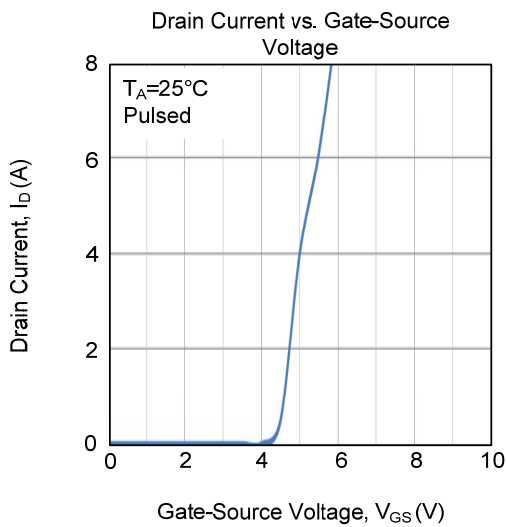
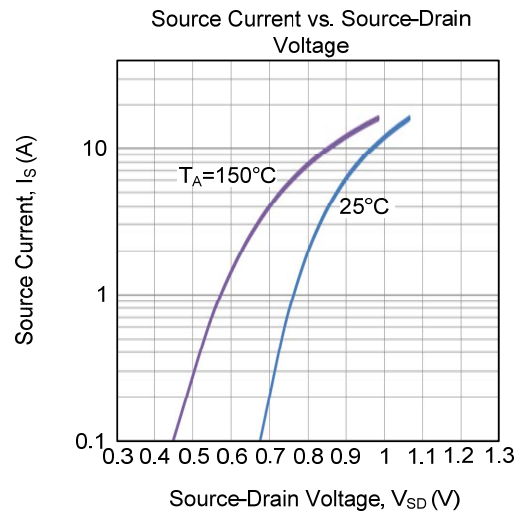
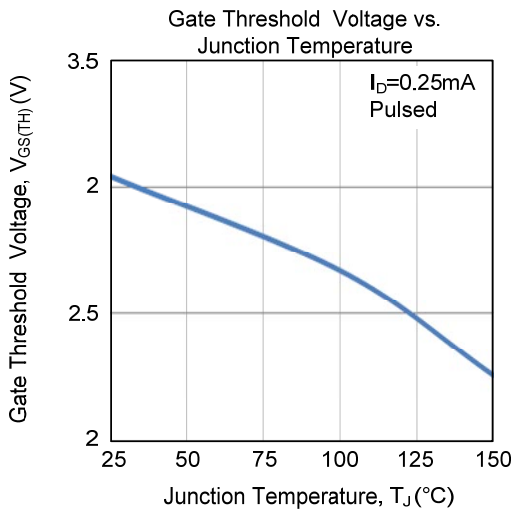


Unclamped Inductive Switching Waveforms

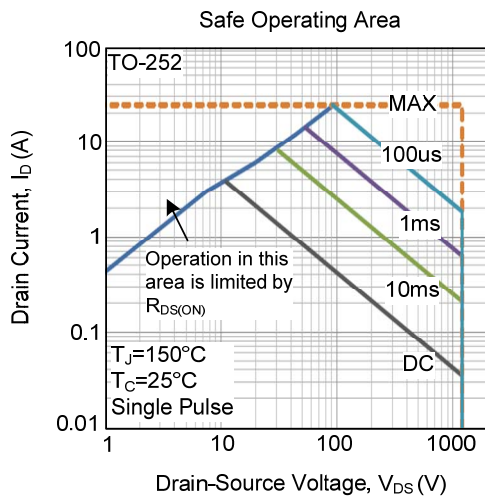
## TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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